-100V

0.117Ω

-23A

AUTOMOTIVE GRADE

International

AUIRF9540N

Features

- Advanced Planar Technology
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax

Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve

low on-resistance per silicon area. This benefit

combined with the fast switching speed and ruggedized device design that HEXFET power

MOSFETs are well known for, provides the designer

with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.

- Lead-Free, RoHS Compliant
- Automotive Qualified*

Description

D	V _{(BR)DSS}
	R _{DS(on)}
s	I _D



max.

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	М	ax.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	-	23	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	-	16	А
I _{DM}	Pulsed Drain Current ①	-76		
P _D @T _C = 25°C	Power Dissipation	1	40	W
	Linear Derating Factor	0	.91	W/°C
V _{GS}	Gate-to-Source Voltage	±	20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited)	430		mJ
I _{AR}	Avalanche Current 0 -11			А
E _{AR}	Repetitive Avalanche Energy ①	14		mJ
dv/dt	Peak Diode Recovery dv/dt ③	-!	5.0	V/ns
TJ	Operating Junction and	-55 te	o + 175	
T _{STG}	Storage Temperature Range			°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	3	00	
	Mounting Torque, 6-32 or M3 screw	10 lbf•in	(1.1N•m)	
Thermal Re	sistance			
	Parameter	Typ.	Max.	Units

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (5)		1.1	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{ heta JA}$	Junction-to-Ambient		62	

HEXFET[®] is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	-100	тур. 		V	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient	-100	0.11		-	Reference to 25°C, $I_D = -1mA$
	Static Drain-to-Source On-Resistance		0.11	0.117	Ω	$V_{GS} = -10V, I_D = -11A$ @
R _{DS(on)}					 V	
V _{GS(th)}	Gate Threshold Voltage	-2.0		-4.0		$V_{DS} = V_{GS}, I_D = -250 \mu A$
gfs	Forward Transconductance	5.3			S	$V_{DS} = -50V, I_D = -11A$
I _{DSS}	Drain-to-Source Leakage Current			-25	μA	$V_{DS} = -100V, V_{GS} = 0V$
				-250		$V_{DS} = -80V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V
Dynamic E	lectrical Characteristics @ T _J =	= 25°C	(unle	ss oth	nerwis	se specified)
	Parameter	Min.	Тур.	Max.	Units	Conditions
Qg	Total Gate Charge			97		I _D = -11A
Q _{gs}	Gate-to-Source Charge			15	nC	V _{DS} = -80V
Q _{gd}	Gate-to-Drain ("Miller") Charge			51	1	V _{GS} = -10V, See Fig. 6 & 13 ④
t _{d(on)}	Turn-On Delay Time		15			V _{DD} = -50V
t _r	Rise Time		67		1	I _D = -11A
t _{d(off)}	Turn-Off Delay Time		51		ns	$R_{G} = 5.1\Omega$
t _f	Fall Time		51		1	R _D = 4.2Ω, See Fig. 10 ④
L _D	Internal Drain Inductance		4.5			Between lead,
-			-		nH	6mm (0.25in.)
Ls	Internal Source Inductance		7.5			from package
0						
C _{iss}	Input Capacitance		1300			and center of die contact s V _{GS} = 0V
Coss	Output Capacitance		400		рF	$V_{DS} = -25V$
C _{rss}	Reverse Transfer Capacitance		240		P.	f = 1.0MHz, See Fig. 5
	aracteristics		240			j = 1.00012, OCC + 1g. 0
Diode Cila	Parameter	Min	Turn	Max	Unite	Conditions
1	Continuous Source Current	Min.	Тур.	Max.	Units	MOSFET symbol
I _S				-23		
1	(Body Diode)			70	A	showing the
I _{SM}	Pulsed Source Current			-76		integral reverse
	(Body Diode) ①					p-n junction diode.
V _{SD}	Diode Forward Voltage			-1.6	V	$T_{J} = 25^{\circ}C, I_{S} = -11A, V_{GS} = 0V$ (4)
t _{rr}	Reverse Recovery Time		150	220	ns	$T_{\rm J} = 25^{\circ} {\rm C}, {\rm I}_{\rm F} = -11{\rm A}$
<u> </u>	Deverse Desevery Charge	1	830	1200	nC	di/dt = 100A/µs ④
Q _{rr}	Reverse Recovery Charge Forward Turn-On Time				-	le (turn-on is dominated by LS+LD)

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Notes:

 ${f O}$ Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

- \odot Starting T_J = 25°C, L = 7.1mH, R_G = 25 Ω , I_{AS} = -11A. (See Figure 12)
- $(\texttt{J} \ I_{SD} \leq \textbf{-11A}, \ di/dt \leq \textbf{-470A}/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_J \leq \textbf{175^{\circ}C}.$
- ④ Pulse width \leq 300µs; duty cycle $\leq 2\%$.

 $\ensuremath{\mathbb{S}}$ R_{theta} is measured at TJ approximately 90°C.

Qualification Information[†]

		Automotive (per AEC-Q101) ^{††}			
Qualificatio	n Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Moisture Se	ensitivity Level	TO-220 N/A			
	Machine Model	Class M4 (+/- 500V) ^{†††}			
			AEC-Q101-002		
500	Human Body Model	Class H1 (+/- 2000V) ^{†††}			
ESD		AEC-Q101-001			
	Charged Device	Class C5 (+/- 2000V) ^{†††}			
	Model	AEC-Q101-005			
RoHS Comp	pliant	Yes			

† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

†† Exceptions to AEC-Q101 requirements are noted in the qualification report.

††† Highest passing voltage



Vs. Temperature





Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case



Fig 12a. Unclamped Inductive Test Circuit



Fig 12b. Unclamped Inductive Waveforms



Fig 13a. Basic Gate Charge Waveform



Fig 12c. Maximum Avalanche Energy Vs. Drain Current



Fig 13b. Gate Charge Test Circuit



Reverse Polarity of D.U.T for P-Channel

*



*** V_{GS} = 5.0V for Logic Level and 3V Drive Devices



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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

- 1 2
- 3
- S: DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994, DIMENSIONS ARE SHOWN IN INCHES (MILLIMETERS). LEAD DIMENSION AND FINISH UNCONTROLLED IN L1. DIMENSION D& E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005° (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERNOST EXTREMES OF THE PLASTIC BODY. DIMENSION D& e AT APPLY TO BASE. METAL ONLY. CONTROLLING DIMENSION : INCHES.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,H1,D2 & E1 DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED,

	DIMENSIONS				
SYMBOL	MILLIM	ETERS	INCHES		1
	MIN.	MAX.	Min,	MAX,	NOTES
A	3.56	4.82	.140	.190	
A1	0,51	1,40	.020	.055	
A2	2.04	2,92	.080	,115	
b	0.38	1.01	.015	.040	
b1	0.38	0.96	.015	.038	5
b2	1,15	1,77	.045	.070	
b3	1.15	1,73	.045	.068	
c	0.36	0.61	.014	.024	
c1	0.36	0,56	.014	.022	5
D	14,22	16,51	,560	.650	4
D1	8,38	9.02	.330	.355	
D2	12,19	12,88	,480	,507	7
E	9.66	10,66	.380	.420	4,7
E1	8.38	8.89	.330	.350	7
e	2.54	2.54 BSC 5.08		.100 BSC .200 BSC	
e1					
H1	5,85	6,55	.230	.270	7,8
L	12.70	14,73	.500	.580	
L1	-	6.35	-	.250	3
øP	3.54	4.08	.139	.161	
Q	2.54	3,42	.100	.135	
ø	90 -	-93	90*	-93	

HEXFET 1.- GATE 2.- DRAIN 3.- SOURCE IGBTs, CoPACK

LEAD ASSIGNMENTS

1,- GATE 2.- COLLECTOR 3,- EMITTER DIODES

1.- ANODE/OPE 2.- CATHODE 3.- ANODE

TO-220AB Part Marking Information



Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF9540N	TO-220	Tube	50	AUIRF9540N

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